



MX-4

Thermal Compound

Main Features

- Easy to apply
- Optimal thermal conductivity
- Low thermal resistance
- Electrically non-conductive
- Non-capacitive
- Non-curing
- Non-corrosive
- Non-bleeding



www.arctic.ac



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The **MX-4**'s consistency is engineered for simplicity of application, superior thermal conductivity and high durability. With its new Formula, the **MX-4** guarantees exceptional heat dissipation from the components and supports the stability needed to push your system to its limit.

The **MX-4** is metal-free and non-electrical conductive which eliminates any risks of causing short circuit, adding more protection to the CPU and VGA cards.

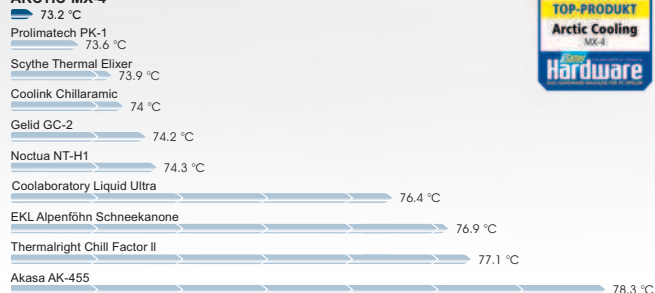
Application

CPU, GPU, power semiconductor components

Specifications

Thermal Conductivity	8.5 W/mK
Viscosity	870 poise
Density	2.5 g/cm ³
Net weight	4 g / 20 g

ARCTIC MX-4



◀◀ Better

Tested on Geforce 8800 GT

Data source: PC Games Hardware, Germany, August 2010, page no. 20-21



4g



20g